

FRAUNHOFER INSTITUTE FOR MICROELECTRONIC CIRCUITS AND SYSTEMS IMS

June 12th and 13th, 2012

6th FRAUNHOFER IMS WORKSHOP

CMOS IMAGING

EXTENDING THE DIMENSIONS



Name / First Name / Title

Affiliation

Address

Phone / Fax

E-Mail

Signature

Please send this completed registration form by May 15th, 2012, at the latest. Fax: +49 203 3783-278

Please note

Registrations are subject to space availability and will be confirmed only after fee payment!

Workshop Fee

550 € (Registration before April 15th, 2012) 700 € (Registration before May 15th, 2012)

The workshop fee includes a USB memory stick with all presentations, lunches, and the evening event on June 12th, 2012.

Cancellations

Half of the payment will be reimbursed for cancellations received before May 15th, 2012. Later cancellations will not be reimbursed!

Terms of Payment

After reception of the registration form, an invoice will be sent to the participants and the fee has to be transferred under reference of the invoice number until May 15th, 2012, at the latest. Payment by credit card is not possible.

Contact at Fraunhofer IMS: Location:

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www.ims.fraunhofer.de www.inhaus.fraunhofer.de

For hotel recommendation and further information see:

http://www.ims.fraunhofer.de/en/veranstaltungen.html

15:30-16:15

16:15-17:00

as of 17:00

CAPDs and 3D-ToF Imaging

Evening Event

Daniel van Nieuwenhove, SoftKinetic

CMOS Sensors for ToF Ranging

Werner Brockherde, Fraunhofer IMS

York Hämisch, Philips

15:00-15:45

as of 16:00

SPAD-Technology and Applications

Franco Zappa, Politecnico di Milano
Visit of wafer fab and inHaus-Zentrum

(subject to space availability)

Objectives and Scope

The past CMOS Imaging Workshops were a great success and were met with very high interest. We want to continue providing a forum to the European industry and academia for important themes on technology, design, and applications of CMOS-based image sensors and systems as well as facilitate discussions on related topics.

Organization

The members of the Program Committee are Prof. Bedrich Hosticka, Ph.D., Mr. Werner Brockherde, and Dr. Daniel Durini. Workshop secretary is Mrs. Cornelia Metz.

Workshop Venue

The workshop will be held at the Fraunhofer inHaus-Zentrum in Duisburg. This center is located downtown Duisburg within 5 minutes walk from the Fraunhofer Institute and can be easily reached either from Duisburg Central Railway Station or from Duesseldorf International Airport.

Evening Event on June 12th, 2012

A dinner is going to take place in the »Seehaus« which is located at the Wedau regatta course in Duisburg.

10:00-10:15	Welcome Address	NONVISIBLE-IMAGING	
	Anton Grabmaier, Fraunhofer IMS	9:00-9:45	Thermal Imagers Based on
			Uncooled Microbolometers
2 D - I M A G I N G			Holger Vogt, Fraunhofer IMS
10:15-11:00	Worse Imagers – Better Images	9:45-10:30	Medical X-Ray Imaging Using Wafer-Scale
	Albert Theuwissen, Harvest Imaging		CMOS Image Sensors
11:00-11:45	Optimizing the Heart		Jan Bosiers, Teledyne DALSA
	of Modern CIS Pixels:	10:30-11:00	Break
	The Pinned Diode and Beyond		
	Amos Fenigstein, TowerJazz	OPTICS &	CAMERA TESTING
11:45-12:30	CMOS Imagers for	11:00-11:45	Optics for CMOS Imagers
	Professional Applications		Ziv Attar, OpEra Optics
	Rainer Schweer, Viimagic	11:45-12:30	Camera Characterisation
	Peter Centen, Grass Valley		Based on EMVA 1288
12:30-13:30	Lunch		Bernd Jähne, University of Heidelberg
13:30-14:15	Space Imaging	12:30-13:30	Lunch
	Dirk Viehmann, Astrium		
		S P A D - I M A G I N G	
3D-TIME-OF-FLIGHT IMAGING		13:30-14:15	Scaleable SPAD Structures for High
14:15-15:00	3D-ToF Imaging with PMD Sensors -		Resolution Single Photon Image Sensors
	Application Requirements and Solutions		Robert Henderson, University of Edinburgh
	Robert Lange, PMD Technologies	14:15-15:00	Fully Integrated Arrays of
15:00-15:30	Break		DIGITAL Si-Photomultipliers